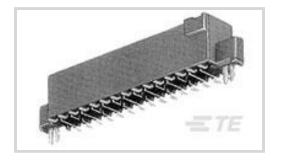
# 104786-6 - ACTIVE

#### AMPMODU | AMPMODU 50/50 Grid

TE Internal #: 104786-6 PCB Mount Receptacle, Vertical, Board-to-Board, 60 Position, 1.27 mm [.05 in] Centerline, Gold, Surface Mount, Signal, Black, AMPMODU 50/50 Grid

View on TE.com >

#### Connectors > PCB Connectors > PCB Headers & Receptacles



### PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **60** 

Number of Rows: 2

#### Features

#### **Product Type Features**

PCB Connector Assembly Type

Connector System

Connector & Contact Terminates To

PCB Mount Receptacle

Board-to-Board

Printed Circuit Board



#### **Configuration Features**

PCB Mount Orientation	Vertical	
Number of Positions	60	
Number of Rows	2	
Board-to-Board Configuration	Parallel	
Electrical Characteristics		
Operating Voltage	30 VAC	
Body Features		
PCB Retention Feature Material	Copper Alloy	
PCB Retention Feature Plating Material	Tin-Lead over Nickel	
Primary Product Color	Black	
Contact Features		
Mating Square Post Dimension	.5 mm[.02 in]	
	150 µin	
PCB Contact Termination Area Plating Material	Tin-Lead	

PCB Mount Receptacle, Vertical, Board-to-Board, 60 Position, 1.27 mm [.05 in] Centerline, Gold, Surface Mount, Signal, Black, AMPMODU 50/50 Grid



Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Socket
Contact Current Rating (Max)	.5 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.08 mm[.003 in]
Rectangular Termination Post & Tail Width	.36 mm[.014 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
PCB Mount Retention Type	Hold-Down Post
Mating Alignment	With
Mating Alignment Type	Polarizing Tab
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

## Housing Features

Centerline (Pitch)	1.27 mm[.05 in]	
Housing Material	LCP - GF (Liquid Crystal Polymer)	
Dimensions		
Connector Height	4.75 mm[.187 in]	
Row-to-Row Spacing	1.27 mm[.05 in]	
PCB Thickness (Recommended)	1.57 mm[.062 in]	
Usage Conditions		
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Solder Process Feature	Board Standoff	
Circuit Application	Signal	
Industry Standards		
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	12	

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Packaging Type	Box, Tube
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**



Also in the Series AMPMODU 50/50 Grid

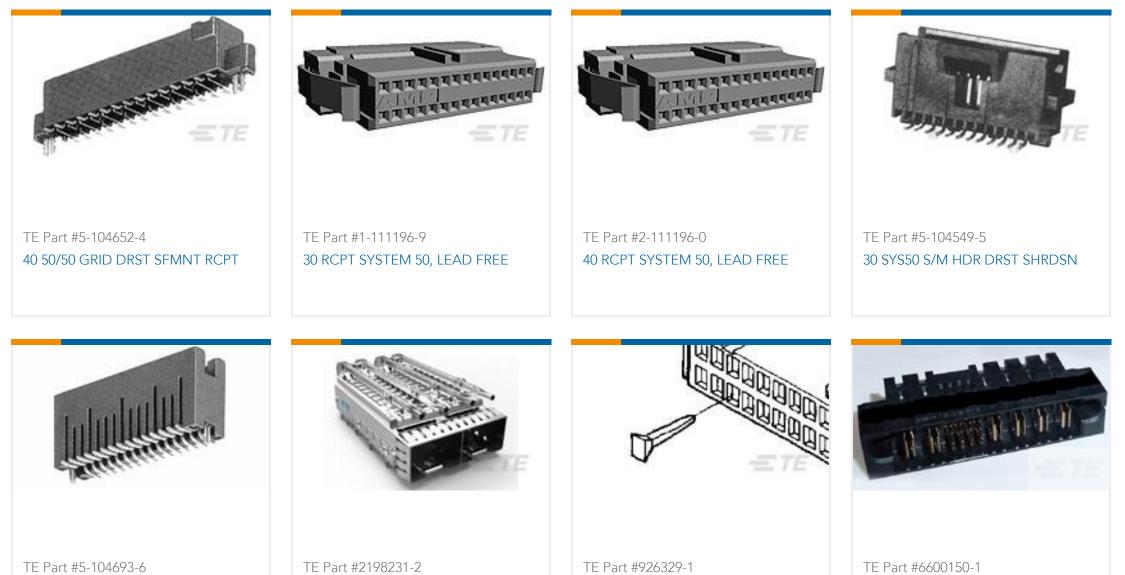
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# **Customers Also Bought**



60 50/50 HDR DRST SFMNT.390 SN	SFP+ Enhanced 1x2, SAN Heatsink, LP	KEYING PLUG	MBXL R/A HDR DB 4P+24S
-E TE			
TE Part #1337769-3	TE Part #1857308-6		
50 OHM COAX BNC STR PLUG STR P	Female, universal power module, M2,5		

## Documents

Product Drawings
60 50/50 GRID DRST SFMNT RCPT

English

Product Specifications

Application Specification

English

Product Environmental Compliance

PCB Mount Receptacle, Vertical, Board-to-Board, 60 Position, 1.27 mm [.05 in] Centerline, Gold, Surface Mount, Signal, Black, AMPMODU 50/50 Grid



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English

MD\_104786-6\_041320151417\_dmtec

English